



UTT130N06M

POWER MOSFET

120A, 60V N-CHANNEL POWER MOSFET

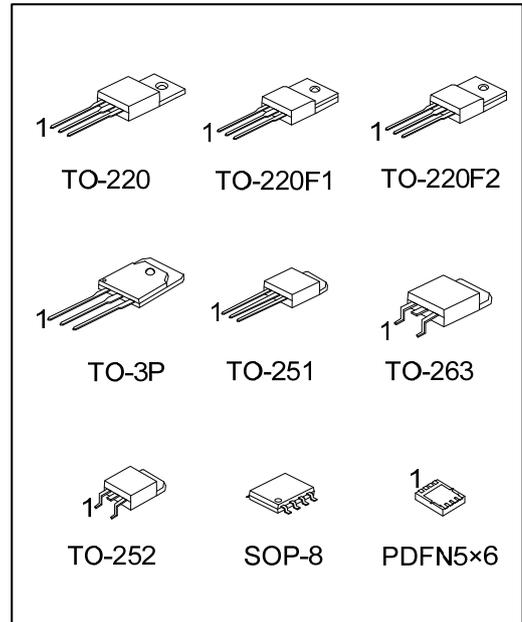
DESCRIPTION

The UTC **UTT130N06M** is a N-channel Power MOSFET, it uses UTC's advanced technology to provide the customers with high switching speed and extremely low on-state resistance, etc.

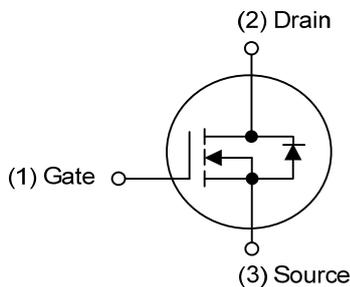
The UTC **UTT130N06M** is suitable for secondary side synchronous rectification, DC-DC converter, motor control and load switching, etc.

FEATURES

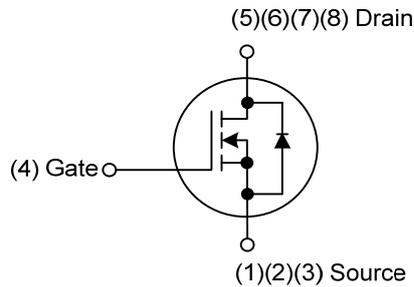
- * High power and current handling capability
- * Low gate charge



SYMBOL



TO-220 / TO-220F1 / TO-220F2
TO-251 / TO-252 / TO-263 / TO-3P



SOP-8 / PDFN5x6

■ ABSOLUTE MAXIMUM RATING ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	60	V	
Gate-Source Voltage		V_{GSS}	± 20	V	
Drain Current	Continuous (Note 2)	TO-220 TO-263	120	A	
		TO-220F1 TO-220F2 TO-3P	80	A	
		TO-251 TO-252	60	A	
		SOP-8 PDFN5×6	50	A	
		Pulsed (Note 3)	TO-220 TO-263	240	A
	TO-220F1 TO-220F2 TO-3P		160	A	
	TO-251 TO-252		120	A	
	SOP-8 PDFN5×6		100	A	
	Avalanche Current		I_{AS}	52	A
	Avalanche Energy (Note 4)		E_{AS}	135	mJ
Power Dissipation		TO-220 TO-263	165	W	
		TO-220F1	36	W	
		TO-220F2	38	W	
		TO-251 TO-252	50	W	
		TO-3P	375	W	
		SOP-8	6	W	
		PDFN5×6	96	W	
		Junction Temperature		T_J	+150
Storage Temperature Range		T_{STG}	-55 ~ +150	$^\circ\text{C}$	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Current limited by bond wire.

3. Pulse width limited by max. junction temperature.

4. $L = 0.1\text{mH}$, $I_{AS} = 52\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT		
Junction to Ambient	TO-220 TO-220F1 TO-220F2 TO-263	θ_{JA}	62.5	°C/W		
	TO-251 TO-252		75	°C/W		
	TO-3P		30	°C/W		
	SOP-8		125	°C/W		
	PDFN5×6		110	°C/W		
	Junction to Case		TO-220 TO-263	θ_{JC}	0.75	°C/W
			TO-220F1		3.4	°C/W
TO-220F2		3.29	°C/W			
TO-251 TO-252		2.5	°C/W			
TO-3P		0.33	°C/W			
SOP-8		20.8	°C/W			
PDFN5×6		1.3	°C/W			

Note: The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

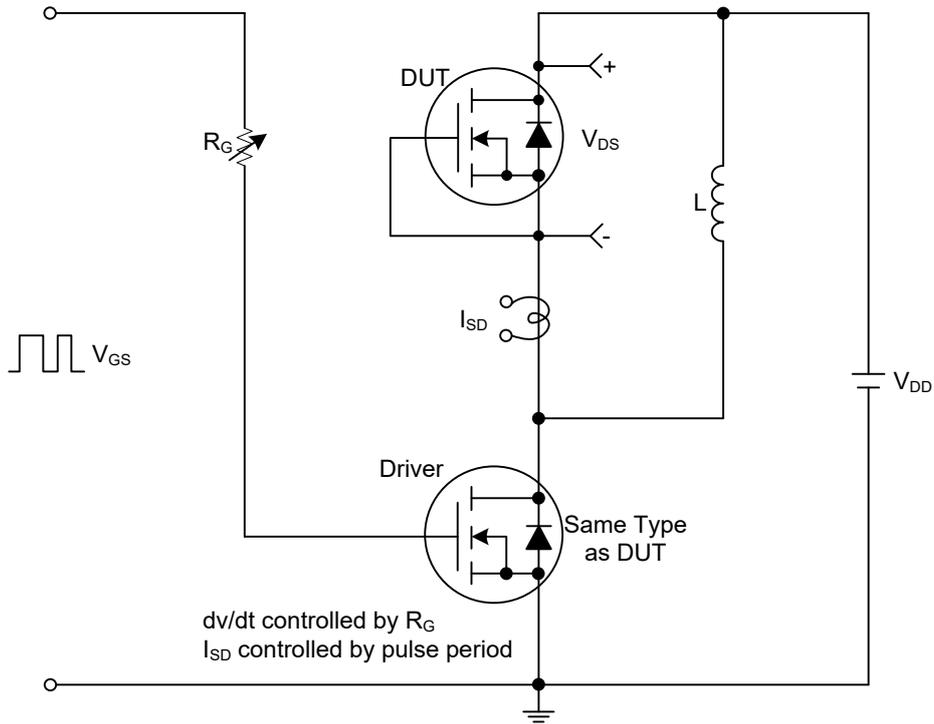
■ ELECTRICAL CHARACTERISTICS (T_J = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	60			V	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V			1	μA	
Gate-Source Leakage Current	Forward	I _{GSS}			+100	nA	
	Reverse						-100
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	1.0	1.8	3.0	V	
Static Drain-Source On-State Resistance (Note 1)	R _{DS(ON)}	V _{GS} =10V, I _D =20A	TO-220			5.9	mΩ
			TO-220F1				
		TO-220F2			6.0	mΩ	
		TO-263					
TO-3P			6.5	mΩ			
TO-251							
TO-252			7.2	mΩ			
SOP-8							
PDFN5×6			9.0	mΩ			
TO-220							
TO-220F1			7.2	mΩ			
TO-220F2							
TO-263			9.0	mΩ			
TO-3P							
TO-251			9.0	mΩ			
TO-252							
SOP-8			9.0	mΩ			
PDFN5×6							
DYNAMIC PARAMETERS (Note 2)							
Input Capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		4950		pF	
Output Capacitance	C _{OSS}			470		pF	
Reverse Transfer Capacitance	C _{RSS}			345		pF	
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)	Q _G	V _{DS} =48V, V _{GS} =10V, I _D =130A, I _G =1mA (Note 1,2)		130		nC	
Gate to Source Charge	Q _{GS}			22		nC	
Gate to Drain Charge	Q _{GD}			37		nC	
Turn-ON Delay Time (Note 1)	t _{D(ON)}	V _{DD} =30V, V _{GS} =10V, I _D =130A, R _G =3Ω, (Note 1,2)		18		ns	
Rise Time	t _R			20		ns	
Turn-OFF Delay Time	t _{D(OFF)}			60		ns	
Fall-Time	t _F			26		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Continuous Drain-Source Diode Forward Current	I _S				40	A	
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				160	A	
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =20A, V _{GS} =0V		0.8	1.3	V	
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =30A, dI _F /dt=100A/μs		44		ns	
Body Diode Reverse Recovery Charge	Q _{rr}				45		nC

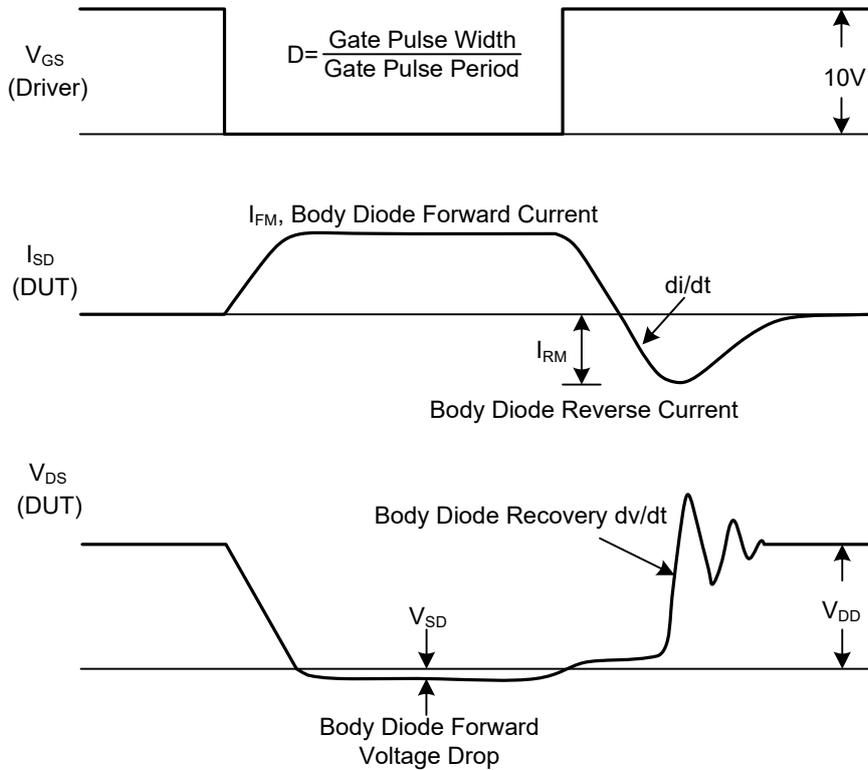
Notes: 1. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%.

2. Guaranteed by design, not subject to production testing.

TEST CIRCUITS AND WAVEFORMS



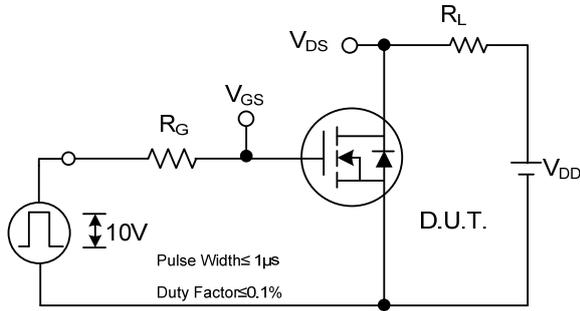
Peak Diode Recovery dv/dt Test Circuit



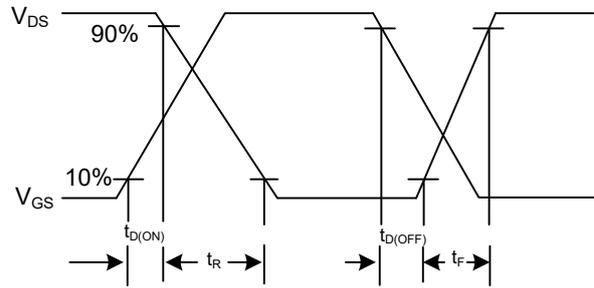
Peak Diode Recovery dv/dt Test Circuit and Waveforms

Peak Diode Recovery dv/dt Waveforms

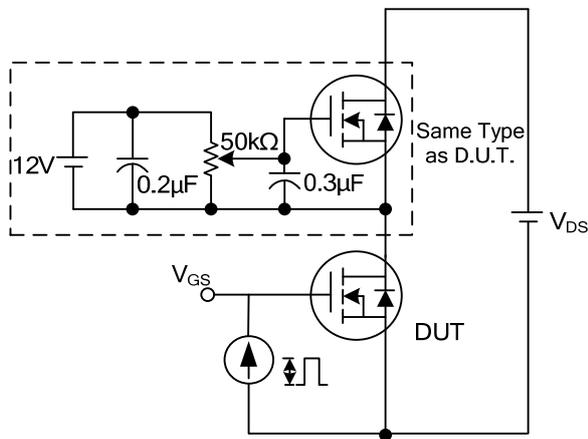
TEST CIRCUITS AND WAVEFORMS



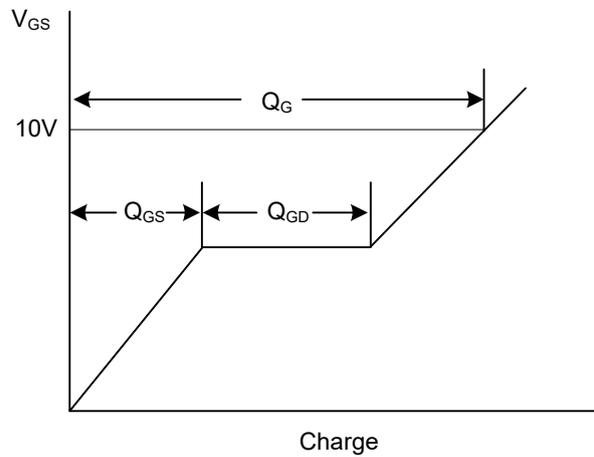
Switching Test Circuit



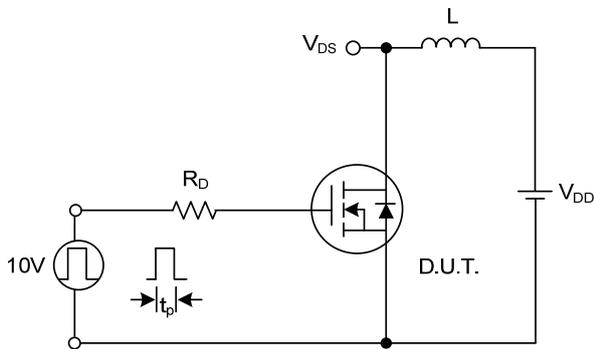
Switching Waveforms



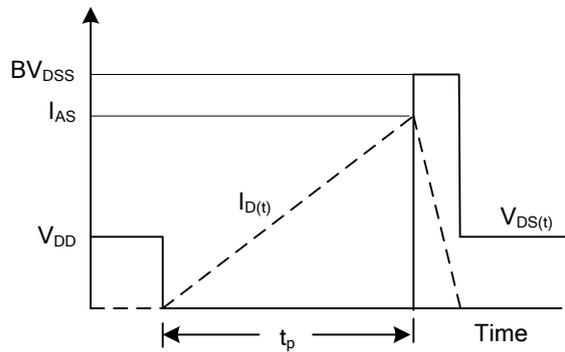
Gate Charge Test Circuit



Gate Charge Waveform

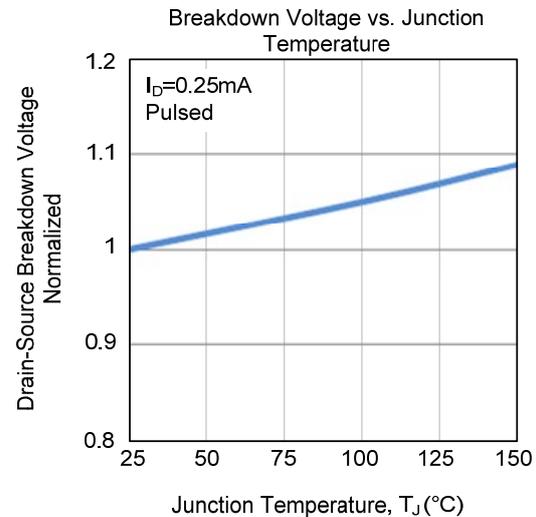
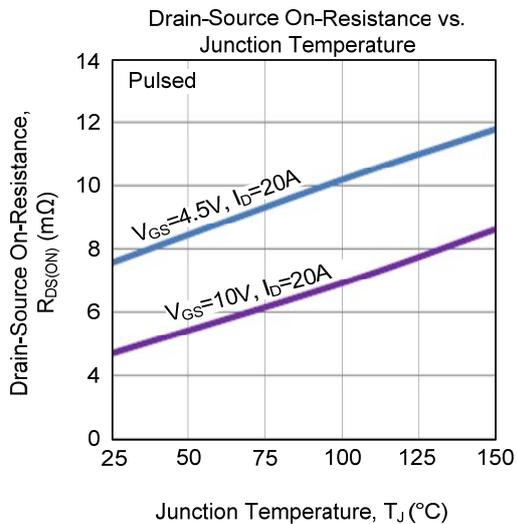
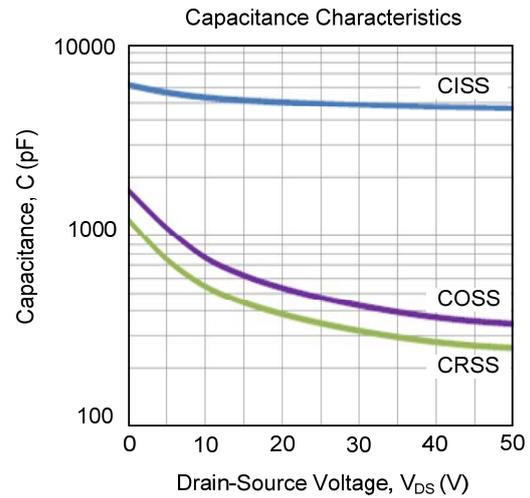
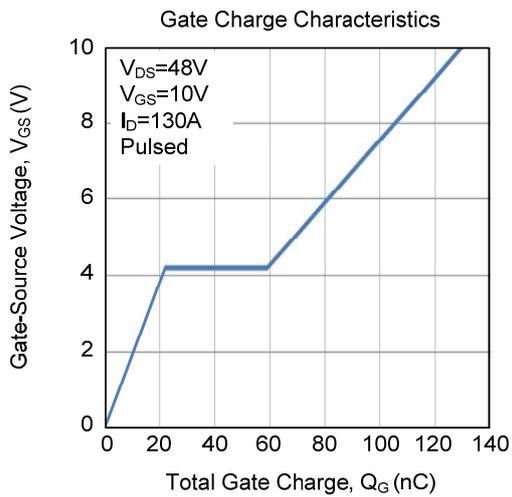
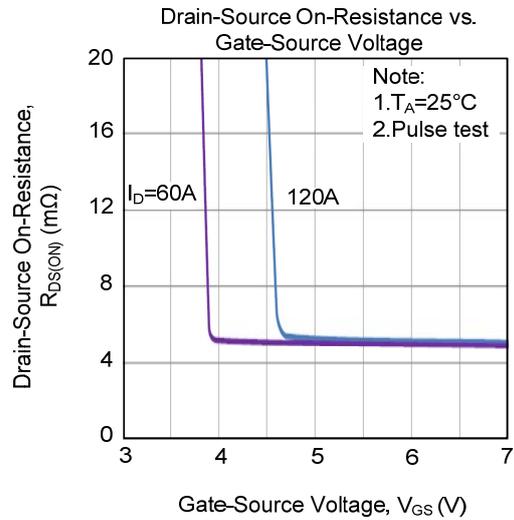
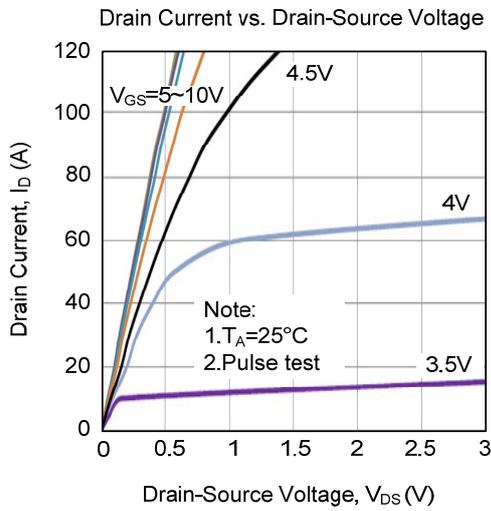


Unclamped Inductive Switching Test Circuit

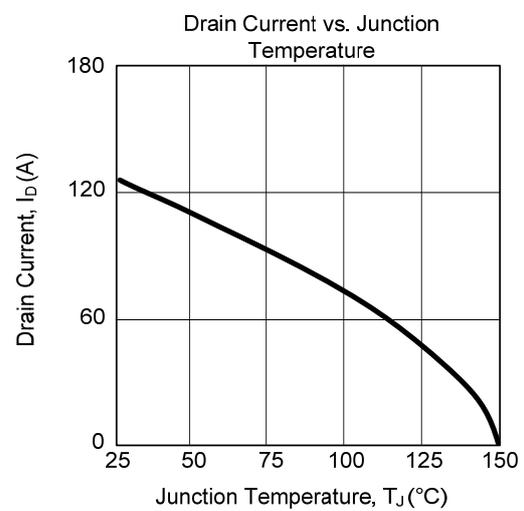
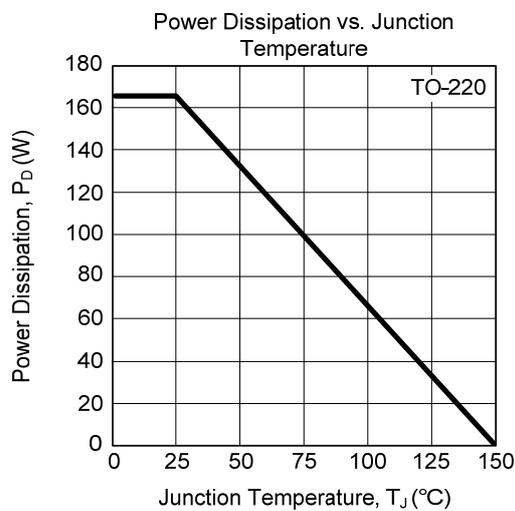
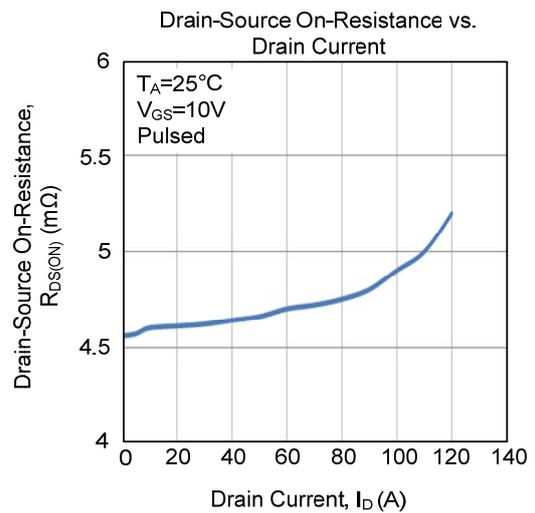
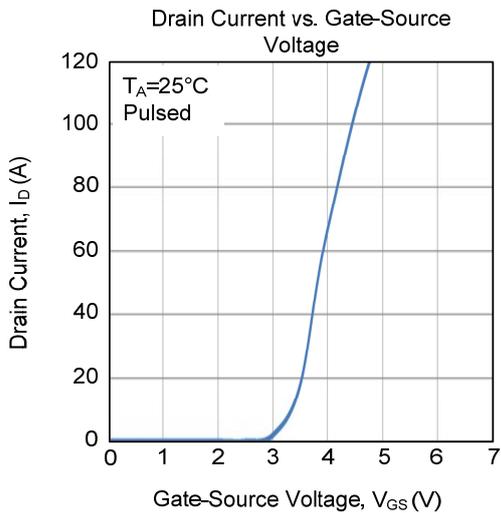
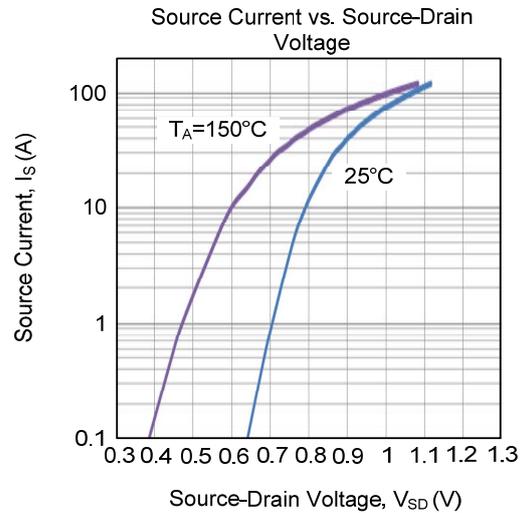
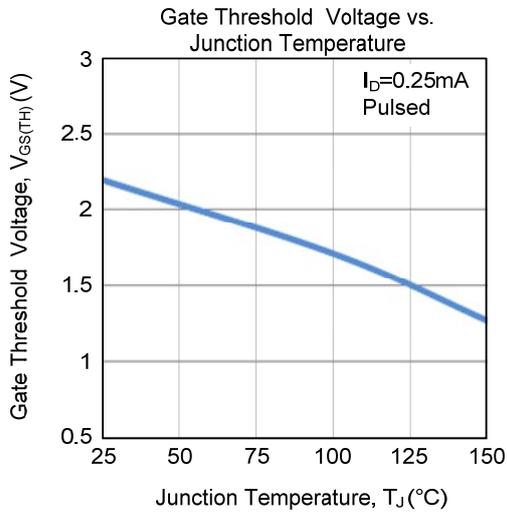


Unclamped Inductive Switching Waveforms

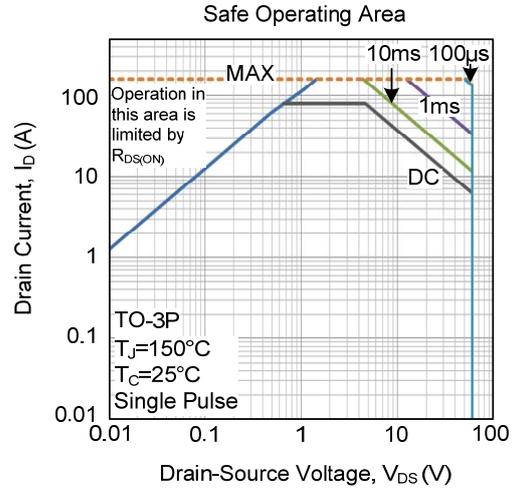
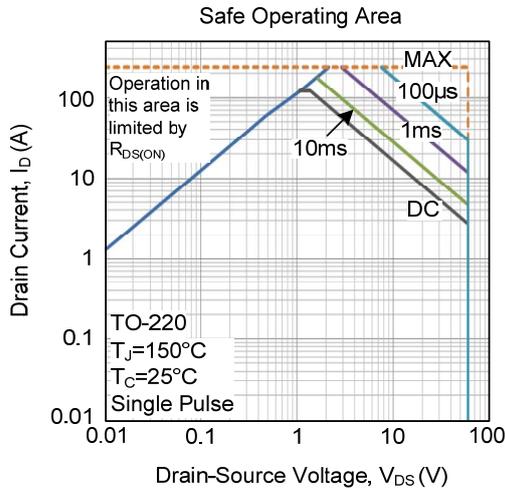
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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